MOSFET - Small Signal, Complementary, SC-88 30 V/-20 V, +0.25/-0.88 A

Features

- Leading 20 V Trench for Low R_{DS(on)} Performance
- ESD Protected Gate
- SC-88 Package for Small Footprint (2 x 2 mm)
- NV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- DC-DC Conversion
- Load/Power Management
- Load Switch
- Cell Phones, MP3s, Digital Cameras, PDAs

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Par	Symbol	Value	Unit		
Drain-to-Source Volt	N-Ch	V_{DSS}	30	V	
		P-Ch		-20	
Gate-to-Source Volta	age	N-Ch	V _{GS}	±20	V
		P-Ch		±12	
N-Channel Continuous Drain	Steady	T _A = 25°C	I _D	0.25	Α
Current (Note 1)	State	T _A = 85°C		0.18	
P-Channel Continuous Drain	Steady	T _A = 25°C		-0.88	
Current (Note 1)	State	T _A = 85°C		-0.63	
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	0.27	W
Pulsed Drain Cur-	N-Ch	to 10	I _{DM}	0.5	Α
rent	P-Ch	tp = 10 μs		-3.0	
Operating Junction as	T _J , T _{stg}	–55 to 150	°C		
Source Current (Body	N-Ch	Is	0.25	Α	
		-0.48			
Lead Temperature for (1/8" from case for 10	TL	260	°C		

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	460	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

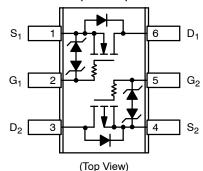


ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
N-Ch	1.0 Ω @ 4.5 V	0.25 A
30 V	1.5 Ω @ 2.5 V	0.25 A
P-Ch	215 mΩ @ -4.5 V	-0.88 A
–20 V	345 mΩ @ –2.5 V	-0.00 A

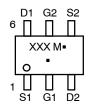




MARKING DIAGRAM & PIN ASSIGNMENT



SC-88 (SOT-363) CASE 419B STYLE 26



XXX = Specific Device Code

M = Date Code ■ Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

1.	Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

OFF CHARACTERISTICS (Note 3) V(BRIDSS PREMIXED NOTATION - Source Breakdown Voltage V(BRIDSS PREMIXED NOTATION - Source Breakdown Voltage Breakdown Voltage (Note 3) V(BRIDSS PREMIXED NOTATION - SOURCE BREAKDOWN VOLTAGE - SOURCE BROOWN VOLTAGE - SOUNCE BROOWN VOLTAGE - SOURCE BROOWN VOLTAGE - SOUNCE BROOWN VOLTAGE - SOUNCE BROOWN VOLTAGE - SOUNCE BROOWN VOLTAGE - SOUNCE BROOWN VOLTAGE - S	Parameter	Symbol	N/P	Test Condition	n	Min	Тур	Max	Unit
Death-In-Source Versiposs P		,	, ,-	1			71-		
Breakdown Voltage P	, ,	V/======	l NI	Ī	I- 250A	20	I	ı	\ \/
Drain-to-Source Breakdown Vigingbss N		V(BR)DSS		V _{GS} = 0 V					V
Voltage Temperature Coefficient T _J P V _{GS} = 0 \ V _{DS} = 30 \ V V _{DS} = 30 \ V V _{DS} = 10 \ V					I _D = -250 μA	-20			
Zero Gate Voltage Drain Current Ioss N V _{GS} = 0 V, V _{DS} = 30 V T _J = 25°C 1.0 1.0 I.0									
P V _{GS} = 0 \ V, V _{DS} = 30 \ V V	<u> </u>				1		-9.0		
P Vos = 0.4 Vps = 16 V Vos = 10 V V	Zero Gate Voltage Drain Current	I _{DSS}			T _{.1} = 25°C				μΑ
P V _{GS} = 0 \ V, V _{DS} = 16 \ V O O O O O O O O O					ŭ			1.0	
P					T ₁ = 125°C		0.5		
P V _{DS} = 0 V, V _{QS} = -4.5 V 0.8 1.0			Р		ŭ		0.5		
On Characteristics (Note 2) Vas(Th) P	Gate-to-Source Leakage Current	I _{GSS}	N	$V_{DS} = 0 V, V_{GS} = 0$	10 V			1.0	μΑ
Reverse Recovery Time Vas(Ti+) N			Р	$V_{DS} = 0 \text{ V}, V_{GS} = -$	4.5 V			1.0	
Negative Gate Threshold Vas(TH) N Temperature Coefficient T N P Vas = 4.5 V, I _D = 10 mA 1.0 1.5 Ω 2.5	ON CHARACTERISTICS (Note 2)								
P VGS = VIS ID = -250 μA -0.45 -0.61 -1.5 Temperature Coefficient T P VGS = -4.5 V, ID = 10 mA -2.7 -2.7 P VGS = -4.5 V, ID = -0.88 A -0.215 0.280 P VGS = -2.5 V, ID = 10 mA -1.5 0.280 P VGS = -2.5 V, ID = -0.71 A -0.45 0.08 -0.8 P VGS = -2.5 V, ID = -0.71 A -0.45 0.08 -0.8 P VGS = -2.5 V, ID = -0.71 A -0.45 0.08 -0.8 P VGS = -2.5 V, ID = -0.71 A -0.45 0.280 P VGS = -2.5 V, ID = -0.71 A -0.48 A -0.65 0.290 Forward Transconductance GFS N VDS = 3.0 V, ID = -0.88 A -0.215 0.280 P VGS = -2.5 V, ID = -0.71 A -0.484 -0.80 -0.8 P VDS = -0.0 V, ID = -0.88 A -0.215 0.280 P VDS = -0.0 V, ID = -0.88 A -0.08 -0.8 P VDS = -0.0 V, ID = -0.88 A -0.20 -0.88 P VDS = -0.0 V, ID = -0.88 A -0.20 -0.88 P VGS = -0.0 V, ID = -0.88 A -0.20 -0.88 P VGS = -0.0 V, ID = -0.88 A -0.20 -0.88 P VGS = -0.0 V, ID = -0.88 A -0.20 -0.88 P VGS = -4.5 V, VDS = -10 V, ID = -0.88 A -0.20 -0.88 P VGS = -4.5 V, VDS = -10 V, ID = -0.88 A -0.20 -0.88 P VGS = -4.5 V, VDS = -10 V, ID = -0.88 A -0.50 -0.88 P VGS = -4.5 V, VDS = -10 V, ID = -0.88 A -0.50 -0.88 Gate-to-Drain Charge QGS N VGS = 5.0 V, VDS = 24 V, ID = 0.1 A -0.20 -0.88 Gate-to-Drain Charge QGS N VGS = -4.5 V, VDS = -10 V, ID = -0.88 A -0.50 -0.88 Gate-to-Drain Charge VGS N VGS = -4.5 V, VDS = -10 V, ID = -0.88 A -0.50 -0.50 -0.50 P VGS = -4.5 V, VDS = -10 V, ID = -0.88 A -0.50 -0	Gate Threshold Voltage	V _{GS(TH)}	N	1	I _D = 100 μA	0.8	1.2	1.5	V
Negative Gate Threshold Temperature Coefficient Trushold Tru	G	GO(111)		$V_{GS} = V_{DS}$		-0.45	-0.61	-1.5	
Page	Negative Gate Threshold	Vocatur/	N		, U.				mV/
Description									°C
P V _{GS} = -4.5 V, I _D = -0.88 A 0.215 0.260 N V _{GS} = 2.5 V, I _D = 10 mA 1.5 2.5 P V _{GS} = -2.5 V, I _D = 0.71 A 0.345 0.500 P V _{GS} = -2.5 V, I _D = -0.71 A 0.345 0.500 P V _{DS} = 3.0 V, I _D = 10 mA 0.08 3.0 P V _{DS} = -10 V, I _D = -0.88 A 3.0 P V _{DS} = -10 V, I _D = -0.88 A 3.0 P V _{DS} = -10 V, I _D = -0.88 A 3.0 P V _{DS} = -10 V, I _D = -0.88 A 3.0 P V _{DS} = -5.0 V V _D	<u>'</u>	_		Voc = 45 V L = 10	0 mΔ	1		1.5	
N V _{GS} = 2.5 V, I _D = 10 mA 1.5 2.5	Diani-to-cource off nesistatice	ייטS(on)							52
P V _{GS} = -2.5 V, I _D = -0.71 A 0.345 0.500			-						ł
Forward Transconductance GFS N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 10 mA 0.08 N VDS = 3.0 V, ID = 3.0 V, I									
CHARGES, CAPACITANCES AND GATE RESISTANCE Input Capacitance								0.500	
The Composition color	Forward Transconductance	9FS					0.08		S
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $			Р	$V_{DS} = -10 \text{ V}, I_D = -0$	D.88 A		3.0		
Part	CHARGES, CAPACITANCES AND	GATE RESIS	STANC	E					
Part	Input Capacitance	C _{ISS}	N		$V_{DS} = 5.0 \text{ V}$		20	33	pF
Output Capacitance			Р	1			155	225	1
Reverse Transfer Capacitance Capacitanc	Output Capacitance	Coss	N	1			19		
$ \begin{array}{ c c c c c } \hline \text{Reverse Transfer Capacitance} & C_{RSS} & N \\ \hline P & V_{QS} = 5.0 \text{ V}, V_{DS} = 20 \text{ V} & 18 & 30 \\ \hline \hline \text{Total Gate Charge} & Q_{G(TOT)} & N & V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V}, I_{D} = 0.1 \text{ A} & 0.9 & 1.5 \\ \hline P & V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V}, I_{D} = -0.88 \text{ A} & 2.2 & 3.5 \\ \hline \text{Threshold Gate Charge} & Q_{G(TH)} & N & V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V}, I_{D} = 0.1 \text{ A} & 0.2 & 2.2 & 3.5 \\ \hline \text{Reverse Transfer Capacitance} & Q_{G(TH)} & N & V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V}, I_{D} = 0.1 \text{ A} & 0.2 & 2.2 & 3.5 \\ \hline P & V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V}, I_{D} = -0.88 \text{ A} & 0.2 & 2.2 & 3.5 \\ \hline \text{Reverse Charge} & Q_{GS} & N & V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V}, I_{D} = 0.1 \text{ A} & 0.2 & 2.2 & 3.5 \\ \hline \text{Reverse Charge} & Q_{GS} & N & V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V}, I_{D} = 0.1 \text{ A} & 0.2 & 2.2 & 3.5 \\ \hline \text{Reverse Charge} & Q_{GS} & N & V_{GS} = 5.0 \text{ V}, V_{DS} = 24 \text{ V}, I_{D} = 0.1 \text{ A} & 0.3 & 0.2 & 2.2 & 3.5 \\ \hline \text{Reverse Charge} & Q_{GS} & N & V_{GS} = 5.0 \text{ V}, V_{DS} = 10 \text{ V}, I_{D} = -0.88 \text{ A} & 0.5 & 3.2 & 3.5 & 3.2 \\ \hline \text{Reverse Charge} & Q_{GS} & N & V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V}, I_{D} = -0.88 \text{ A} & 0.5 & 3.2 & 3.5 \\ \hline \text{Reverse Revovey Time} & \text{t}_{d(ON)} & N & \text{t}_{GS} = 4.5 \text{ V}, V_{DS} = -10 \text{ V}, I_{D} = -0.88 \text{ A} & 0.5 & 3.2 & 3.5 \\ \hline \text{Reverse Recovery Time} & \text{t}_{d(ON)} & N & \text{t}_{GS} = 4.5 \text{ V}, V_{DS} = -10 \text{ V}, I_{D} = -0.88 \text{ A} & 0.5 & 3.2 & 3.5 \\ \hline \text{Reverse Recovery Time} & \text{t}_{d(OFF)} & \text{t}_{D} = 250 \text{ mA}, R_{G} = 50 \Omega & 5.0 & 5.0 & 3.2 & 3.5 & 3.2 \\ \hline \text{Reverse Recovery Time} & \text{t}_{d(OFF)} & \text{t}_{GS} = 0 \text{ V}, T_{J} = 25^{\circ}\text{C} & \frac{I_{S} = 10 \text{ mA}}{I_{S} = -0.48 \text{ A}} & -0.66 & 3.2 & 3.5 & 3.2 & 3.5 & 3.2 \\ \hline \text{Reverse Recovery Time} & \text{t}_{RR} & N & \text{V}_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C} & \frac{I_{S} = 10 \text{ mA}}{I_{S} = -0.48 \text{ A}} & -0.66 & 3.2 & 3.5 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3.2 & 3$		-000		f = 1 MHz, V _{GS} = 0 V					1
P	Reverse Transfer Canacitance	Cnoo		1					-
Total Gate Charge	Theverse Transfer Supucitainee	ORSS		1					
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Total Cata Charge		-	V 50VV 04V					~C
$ \begin{array}{ c c c c c c c c c } \hline \mbox{Threshold Gate Charge} & Q_{G(TH)} & N & V_{GS} = 5.0 \ V, V_{DS} = 24 \ V, \ I_{D} = 0.1 \ A & 0.2 & 0.$	Total Gate Charge	QG(TOT)							nC
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	T							3.5	
Gate-to-Source Charge Page Pag	Threshold Gate Charge	$Q_{G(TH)}$							
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$									
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Gate-to-Source Charge	Q_GS					0.3		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$			Р	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$	$I_D = -0.88 A$		0.5		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Gate-to-Drain Charge	Q_{GD}							
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$			Р	$V_{GS} = -4.5 \text{ V}, V_{DS} = -10 \text{ V},$	$I_D = -0.88 A$		0.65		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	SWITCHING CHARACTERISTICS (Note 3)							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Turn-On Delay Time	td(ON)	N	1			15		ns
$ \begin{array}{ c c c c }\hline \text{Turn-Off Delay Time} & t_{d(OFF)} \\\hline \text{Fall Time} & t_{f} \\\hline \text{Turn-On Delay Time} & t_{d(ON)} \\\hline \text{Rise Time} & t_{f} \\\hline \text{Turn-Off Delay Time} & t_{d(ON)} \\\hline \text{Fall Time} & t_{f} \\\hline \text{Turn-Off Delay Time} & t_{d(OFF)} \\\hline \text{Fall Time} & t_{f} \\\hline \end{array} \begin{array}{ c c c c c c c c c c c c c c c c c c c$	•		1	Voc = 45 V Voc -	5.0 V				1
		<u> </u>	1			-		 	ł
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	· · · · · · · · · · · · · · · · · · ·	1	-	.b - 255, (, rig -				 	ł
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		` ′	-						
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$						<u> </u>	3.5	<u> </u>	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		=							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Forward Diode Voltage	V_{SD}	N	Vac = 0.V.T. 25°C	I _S = 10 mA		0.65	0.7	V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			Р	v _{GS} = 0 v, 1 _J = 25 °C	$I_S = -0.48 \text{ A}$		-0.8	-1.2	1
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			N	V 0V T 10500	I _S = 10 mA	1	0.45		1
Reverse Recovery Time $ t_{RR} \qquad N \qquad V_{GS} = 0 \; V, \; d_{IS}/d_t = 8.0 \; A/\mu s \qquad I_S = 10 \; mA \qquad \qquad 12.4 \qquad \qquad ns $			Р	V _{GS} = 0 V, I _J = 125°C		i e	-0.66		1
	Reverse Recovery Time	tee	N	$V_{GS} = 0 \text{ V}, d_{1S}/d_t = 8.0 \text{ A/Hs}$		l			ns
$I = I + I + V_{CC} = 0.0 \text{ M/H} = 100 \text{ A/H} = -0.48 \text{ MA} = 1.10 \text{ A} = 1.00 \text{ A} = -0.48 \text{ MA} = 1.10 \text{ A} = 1.00 \text{ A} = 1.$	•	""	P	$V_{GS} = 0 \text{ V}, d_{IS}/d_t = 100 \text{ A/}\mu\text{s}$	$I_S = -0.48 \text{ mA}$		10.6		1

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

TYPICAL N-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

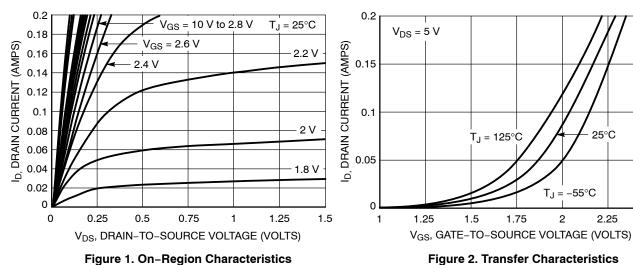
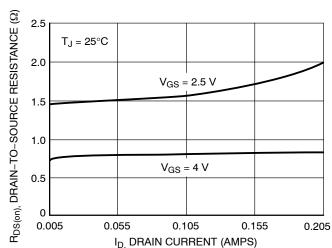


Figure 1. On-Region Characteristics



2.5

RDS(on), DRAIN-TO-SOURCE RESISTANCE (♥) 1.3 V_{GS} = 4.5 V $T_J = 125^{\circ}C$ 1.2 1.1 1.0 0.9 $T_J = 25^{\circ}C$ 8.0 0.7 0.6 $T_J = -55^{\circ}C$ 0.055 0.105 0.155 0.205 0.005 ID DRAIN CURRENT (AMPS)

Figure 3. On-Resistance vs. Drain Current and **Temperature**

Figure 4. On-Resistance vs. Drain Current and **Gate Voltage**

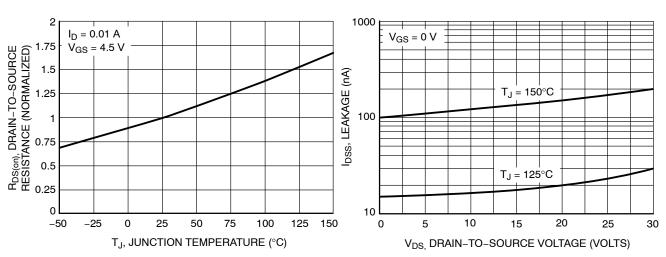
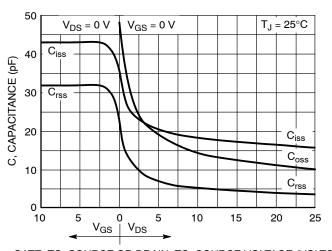


Figure 5. On-Resistance Variation with **Temperature**

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL N-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 7. Capacitance Variation

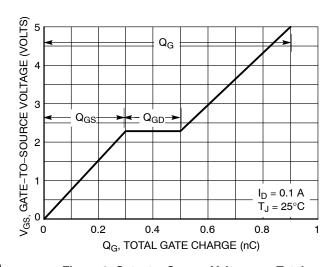


Figure 8. Gate-to-Source Voltage vs. Total Gate Charge

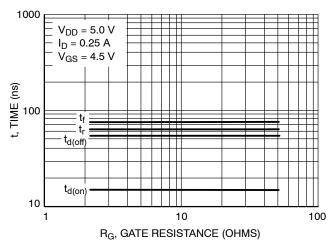


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

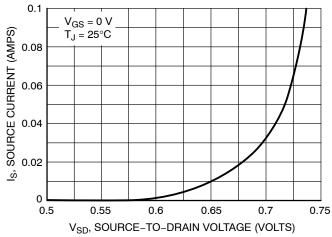


Figure 10. Diode Forward Voltage vs. Current

TYPICAL P-CHANNEL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

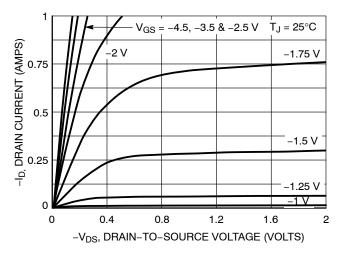


Figure 1. On-Region Characteristics

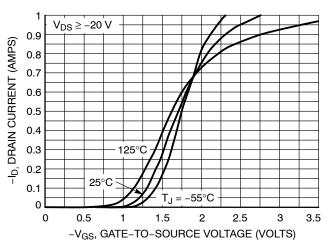


Figure 2. Transfer Characteristics

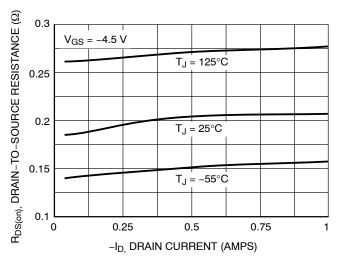


Figure 3. On–Resistance vs. Drain Current and Temperature

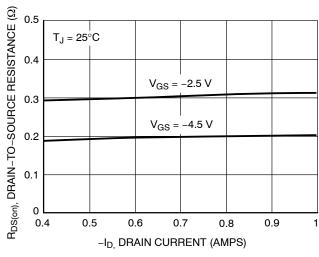


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

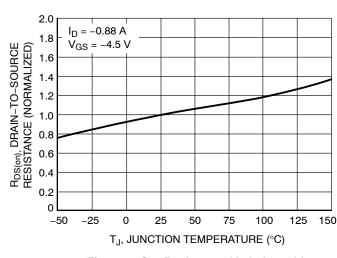


Figure 5. On–Resistance Variation with Temperature

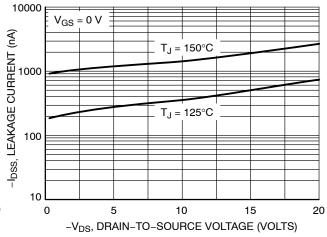
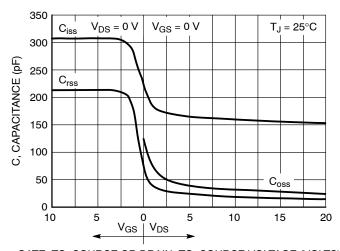


Figure 6. Drain-to-Source Leakage Current vs. Voltage

$\textbf{TYPICAL P-CHANNEL PERFORMANCE CURVES} \ \, (\textbf{T}_{J} = 25^{\circ} \text{C unless otherwise noted})$



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 7. Capacitance Variation

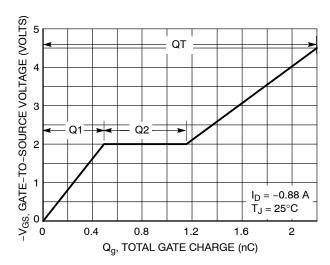


Figure 8. Gate-to-Source Voltage vs. Total Gate Charge

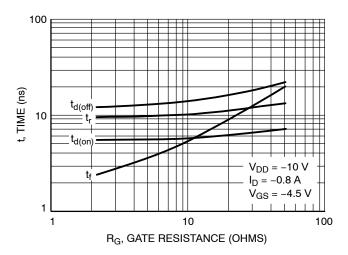


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

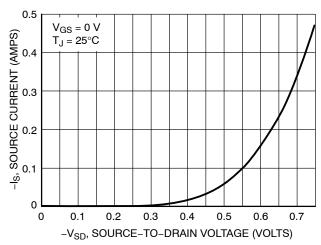


Figure 10. Diode Forward Voltage vs. Current

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTJD4158CT1G	TCD		
NTJD4158CT2G	TCD	SC-88 (Pb-Free)	3000 / Tape & Reel
NVJD4158CT1G*	VCD	,	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

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NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H. DATUMS A AND B ARE DETERMINED AT DATUM H. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.

- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

	MIL	LIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α			1.10			0.043	
A1	0.00		0.10	0.000		0.004	
A2	0.70	0.90	1.00	0.027	0.035	0.039	
b	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.08	0.15	0.22	0.003	0.006	0.009	
D	1.80	2.00	2.20	0.070	0.078	0.086	
E	2.00	2.10	2.20	0.078	0.082	0.086	
E1	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65 BS	С	0	.026 BS	С	
L	0.26	0.36	0.46	0.010	0.014	0.018	
L2		0.15 BS	C		0.006 BS	SC	
aaa		0.15			0.006		
bbb		0.30			0.012		
ccc		0.10			0.004		
ddd		0.10			0.004		

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code* = Pb-Free Package

(Note: Microdot may be in either location)

- *Date Code orientation and/or position may vary depending upon manufacturing location.
- *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13: PIN 1. ANODE 2. N/C 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 14: PIN 1. VREF 2. GND 3. GND 4. IOUT 5. VEN 6. VCC	STYLE 15: PIN 1. ANODE 1 2. ANODE 2 3. ANODE 3 4. CATHODE 3 5. CATHODE 2 6. CATHODE 1	STYLE 16: PIN 1. BASE 1 2. EMITTER 2 3. COLLECTOR 2 4. BASE 2 5. EMITTER 1 6. COLLECTOR 1	STYLE 17: PIN 1. BASE 1 2. EMITTER 1 3. COLLECTOR 2 4. BASE 2 5. EMITTER 2 6. COLLECTOR 1	STYLE 18: PIN 1. VIN1 2. VCC 3. VOUT2 4. VIN2 5. GND 6. VOUT1
STYLE 19: PIN 1. I OUT 2. GND 3. GND 4. V CC 5. V EN 6. V REF	STYLE 20: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER 5. COLLECTOR 6. COLLECTOR	STYLE 21: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. N/C 6. CATHODE 1	STYLE 22: PIN 1. D1 (i) 2. GND 3. D2 (i) 4. D2 (c) 5. VBUS 6. D1 (c)	STYLE 23: PIN 1. Vn 2. CH1 3. Vp 4. N/C 5. CH2 6. N/C	STYLE 24: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE
STYLE 25: PIN 1. BASE 1 2. CATHODE 3. COLLECTOR 2 4. BASE 2 5. EMITTER 6. COLLECTOR 1	STYLE 26: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1	STYLE 27: PIN 1. BASE 2 2. BASE 1 3. COLLECTOR 1 4. EMITTER 1 5. EMITTER 2 6. COLLECTOR 2	STYLE 28: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE 29: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE/ANODE 6. CATHODE	STYLE 30: PIN 1. SOURCE 1 2. DRAIN 2 3. DRAIN 2 4. SOURCE 2 5. GATE 1 6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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